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PATENT
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: John W. Ladd

Serial No.: 10/035,738

Filed: November 7, 2001

For: APPARATUS FOR ESTABLISHING
AN ELECTRICAL CONNECTION WITH A
WAFER TO FACILITATE WAFER-LEVEL
BURN-IN AND METHODS

Examiner: R. Chang

Group Art Unit: 2833

Attorney Docket No.: 2269-4584.1US
(00-0787.01/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

October 10, 2003
Date

[Signature]
Signature

Deidra Pfeil

Name (Type/Print)

AMENDMENT

Commissioner for Patents
Mail Stop Non-Fee Amendment
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Office Action of July 10, 2003, the initial period for response to which expires on October 10, 2003.

Amendments to the Title appear on page 2 of this paper;

Amendments to the Abstract are on page 3 of this paper;

Amendments to the Claims are set forth in the listing of the claims, which begins on page 4 of this paper; and

Remarks start at page 7 of this paper.

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IN THE TITLE:

Please amend the title, which appears on the cover page and at the top of page 2 of the above-referenced application, as follows:

APPARATUS METHODS FOR MAGNETICALLY ESTABLISHING AN ELECTRICAL
CONNECTION WITH A CONTACT OF A SEMICONDUCTOR DEVICE
COMPONENT ~~WAFER TO FACILITATE WAFER-LEVEL BURN-IN AND METHODS~~